Bill of Materials

TI DESIGNS

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Pros	Ref Name	Number of Per Board	Description
1	R1 to R8	8	390Ohm SMD0603 resistor
2	R9	1	180Ohm SMD0603 resistor
3	LED1 to LED8	8	Top LED red wtr clr 631NM 1206
4	LED9	1	LED white round dissused 1206
5	J1, J2	2	Female header SSM-110-L-SV 2.54mm
6	R10 to R15	0	SMD0603 resistor (not populated)

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